

## 650V N-ch Planar MOSFET

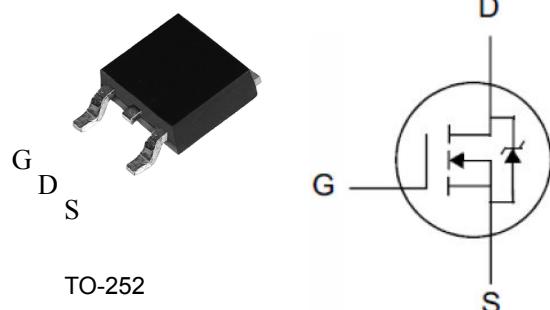
### General Features

- RoHS Compliant
- $R_{DS(ON),typ.} = 1.2 \Omega$  @  $V_{GS} = 10V$
- Low Gate Charge Minimize Switching Loss
- Fast Recovery Body Diode

### Applications

- Adaptor
- Charger
- SMPS Standby Power

$BV_{DSS}$	$R_{DS(ON),Typ.}$	$I_D$
650V	1.2Ω	7.0A



TO-252

### Ordering Information

Part Number	Package
SK07N65B	TO-252

### Absolute Maximum Ratings

$T_c = 25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	SK07N65B	Unit
$V_{DSS}$	Drain-to-Source Voltage	650	V
$V_{GSS}$	Gate-to-Source Voltage	$\pm 30$	
$I_D$	Continuous Drain Current	7.0	A
$I_{DM}$	Pulsed Drain Current at $V_{GS} = 10V$	28	
$E_{AS}$	Single Pulse Avalanche Energy	550	mJ
$P_D$	Power Dissipation	126	W
	Derating Factor above $25^\circ\text{C}$	1.0	W/ $^\circ\text{C}$
$T_L$ $T_{PAK}$	Maximum Temperature for Soldering Leads at 0.063in (1.6mm) from Case for 10 seconds, Package Body for 10 seconds	300 260	$^\circ\text{C}$
$T_J$ & $T_{STG}$	Operating and Storage Temperature Range	-55 to 150	

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.

### Thermal Characteristics

Symbol	Parameter	SK07N65B	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.99	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	75	

## Electrical Characteristics

### OFF Characteristics

 $T_J = 25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
$\text{BV}_{\text{DSS}}$	Drain-to-Source Breakdown Voltage	650	--	--	V	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$
$\text{I}_{\text{DSS}}$	Drain-to-Source Leakage Current	--	--	1	uA	$\text{V}_{\text{DS}}=650\text{V}, \text{V}_{\text{GS}}=0\text{V}$
		--	--	100		$\text{V}_{\text{DS}}=520\text{V}, \text{V}_{\text{GS}}=0\text{V}, \text{T}_J=125^\circ\text{C}$
$\text{I}_{\text{GSS}}$	Gate-to-Source Leakage Current	--	--	+100	nA	$\text{V}_{\text{GS}}=+30\text{V}, \text{V}_{\text{DS}}=0\text{V}$
		--	--	-100		$\text{V}_{\text{GS}}=-30\text{V}, \text{V}_{\text{DS}}=0\text{V}$

### ON Characteristics

 $T_J = 25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
$R_{\text{DS}(\text{ON})}$	Static Drain-to-Source On-Resistance	--	1.2	1.40	$\Omega$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=3.5\text{A}$
$\text{V}_{\text{GS}(\text{TH})}$	Gate Threshold Voltage	2.0	--	4.0	V	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$
$g_{\text{fs}}$	Forward Transconductance	--	11	--	S	$\text{V}_{\text{DS}}=30\text{V}, \text{I}_D=3.5\text{A}$

### Dynamic Characteristics

Essentially independent of operating temperature

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
$C_{\text{iss}}$	Input Capacitance	--	1120	--	pF	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=25\text{V}, f=1.0\text{MHz}$
$C_{\text{rss}}$	Reverse Transfer Capacitance	--	10	--		
$C_{\text{oss}}$	Output Capacitance	--	90	--		
$Q_g$	Total Gate Charge	--	20	--	nC	$\text{V}_{\text{DD}}=325\text{V}, \text{I}_D=7\text{A}, \text{V}_{\text{GS}}=0 \text{ to } 10\text{V}$
$Q_{\text{gs}}$	Gate-to-Source Charge	--	5	--		
$Q_{\text{gd}}$	Gate-to-Drain (Miller) Charge	--	5	--		

### Resistive Switching Characteristics

Essentially independent of operating temperature

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
$t_{\text{d}(\text{ON})}$	Turn-on Delay Time	--	12	--	ns	$\text{V}_{\text{DD}}=325\text{V}, \text{I}_D=7\text{A}, \text{V}_{\text{GS}}=10\text{V}, \text{R}_g=4.7\Omega$
$t_{\text{rise}}$	Rise Time	--	12	--		
$t_{\text{d}(\text{OFF})}$	Turn-Off Delay Time	--	18	--		
$t_{\text{fall}}$	Fall Time	--	10	--		

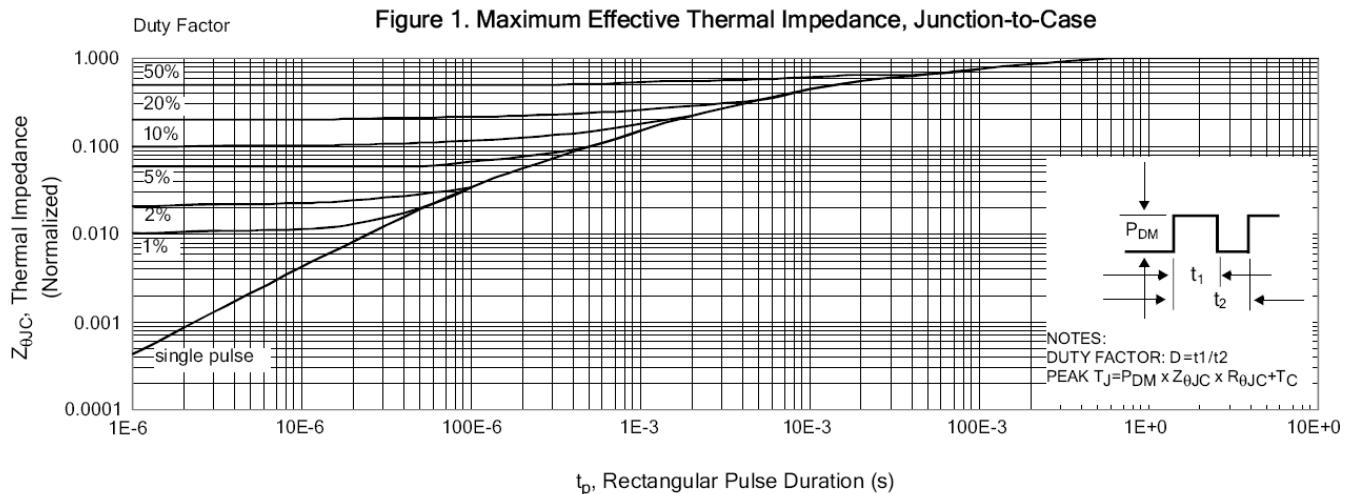
**Source-Drain Body Diode Characteristics**
 $T_J=25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	Min	Typ.	Max.	Unit	Test Conditions
$I_{SD}$	Continuous Source Current <sup>[2]</sup>	--	--	7.0	A	Integral pn-diode in MOSFET
$I_{SM}$	Pulsed Source Current <sup>[2]</sup>	--	--	28		
$V_{SD}$	Diode Forward Voltage	--	--	1.5	V	$I_S=7\text{A}$ , $V_{GS}=0\text{V}$
$t_{rr}$	Reverse Recovery Time	--	350	--	ns	$V_{GS}=0\text{V}$
$Q_{rr}$	Reverse Recovery Charge	--	1.1	--	uC	$I_F=7\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$

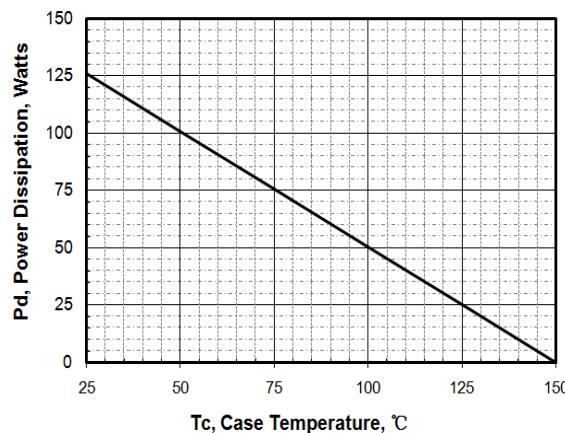
**Note:** [1]  $T_J=+25^\circ\text{C}$  to  $+150^\circ\text{C}$ 

[2] Pulse width $\leq 380\mu\text{s}$ ; duty cycle $\leq 2\%$ .

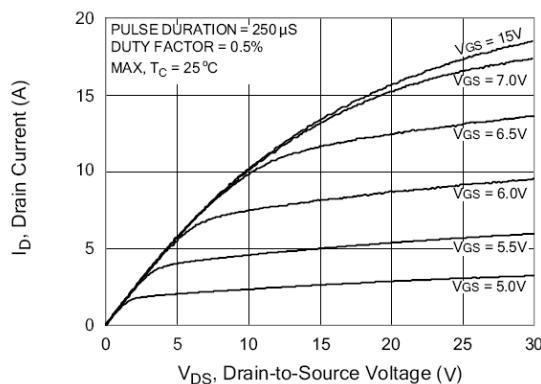
## Typical Characteristics



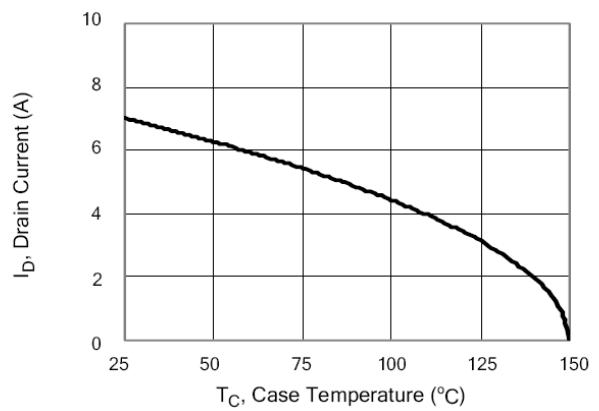
**Figure 2 . Max. Power Dissipation vs Case Temperature**



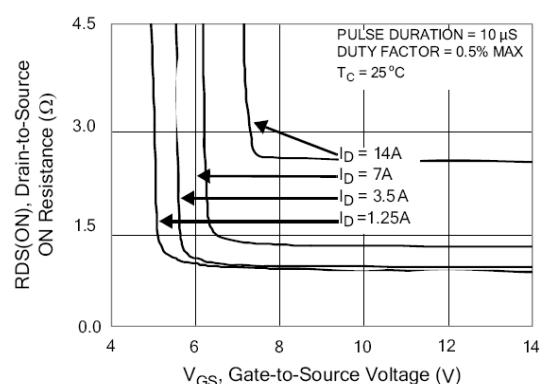
**Figure 4. Typical Output Characteristics**



**Figure 3. Maximum Continuous Drain Current vs Case Temperature**



**Figure 5. Typical Drain-to-Source ON Resistance vs Gate Voltage and Drain Current**



## Typical Characteristics(Cont.)

Figure 6. Maximum Peak Current Capability

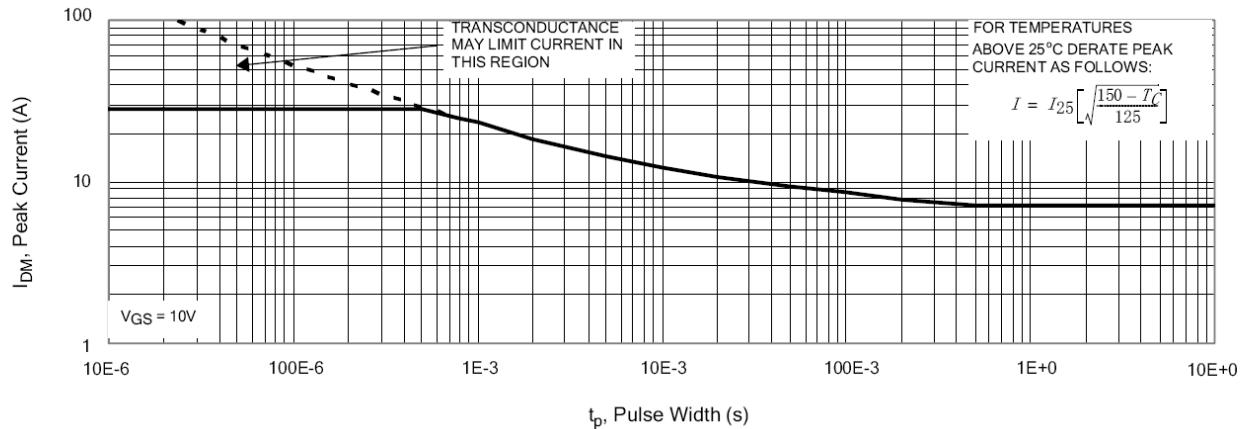


Figure 7. Typical Transfer Characteristics

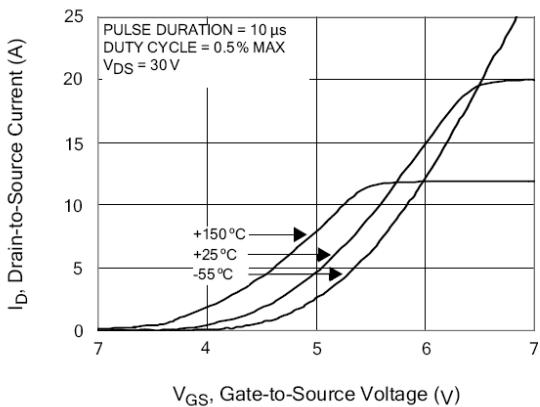


Figure 8. Unclamped Inductive Switching Capability

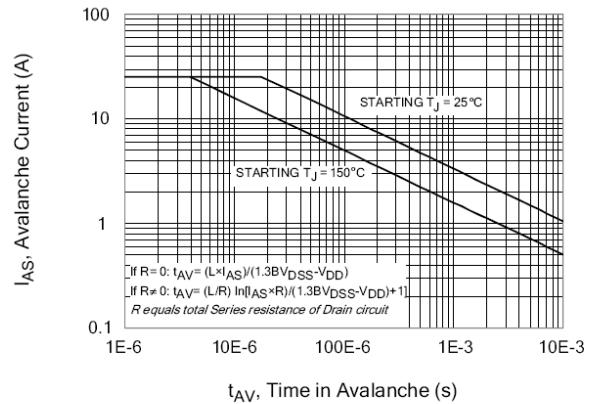


Figure 9. Typical Drain-to-Source ON Resistance vs Drain Current

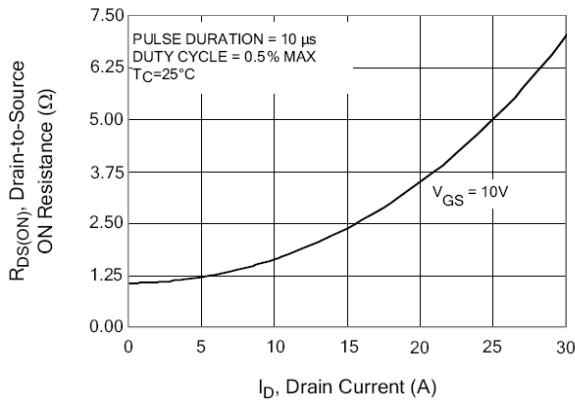
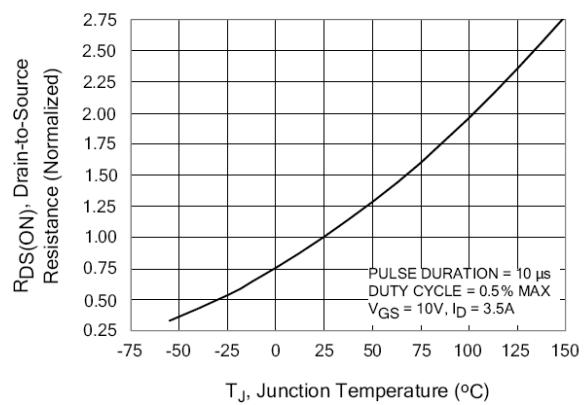


Figure 10. Typical Drain-to-Source ON Resistance vs Junction Temperature



## Typical Characteristics(Cont.)

Figure 11. Typical Breakdown Voltage vs Junction Temperature

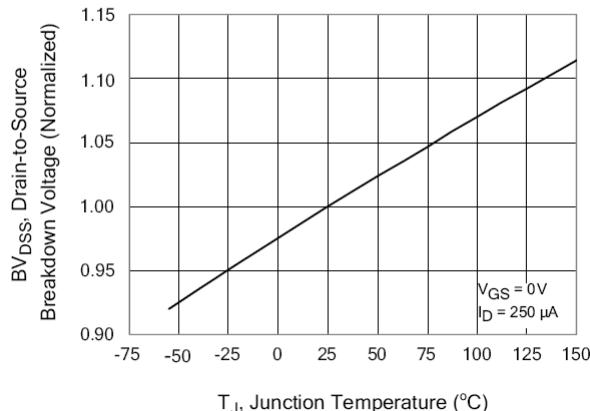


Figure 12. Typical Threshold Voltage vs Junction Temperature

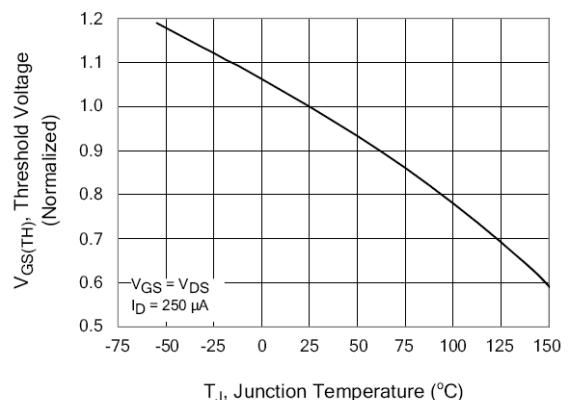


Figure 13 . Maximum Safe Operating Area

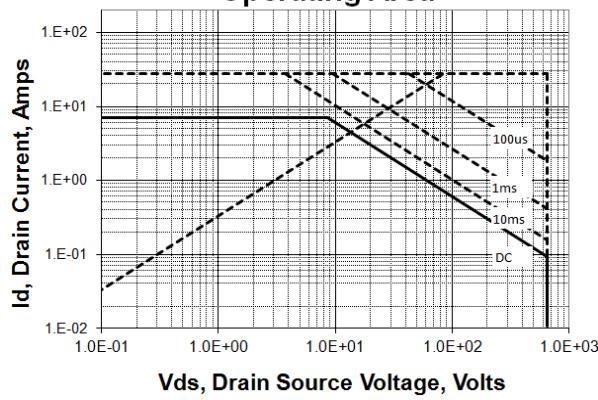


Figure 14. Capacitance vs Vds

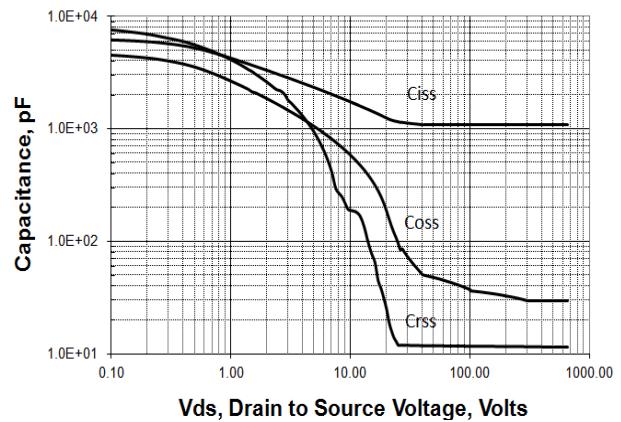


Figure 15 .Typical Gate Charge

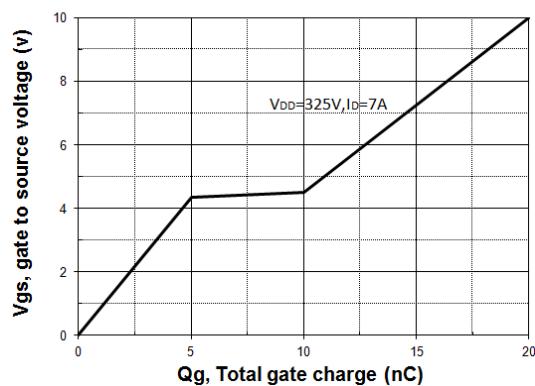
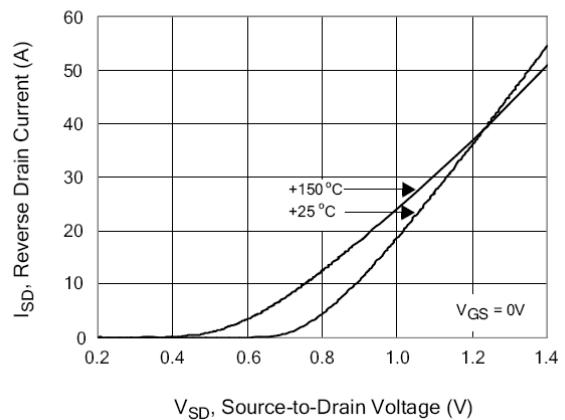


Figure 16. Typical Body Diode Transfer Characteristics



## Test Circuits and Waveforms

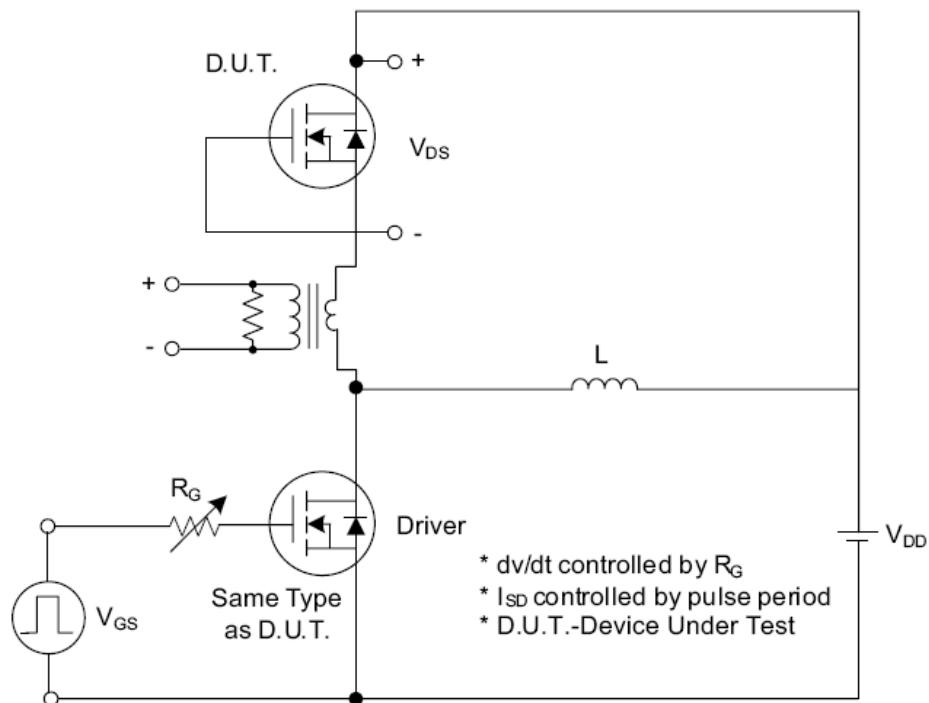


Fig. 1.1 Peak Diode Recovery  $dv/dt$  Test Circuit

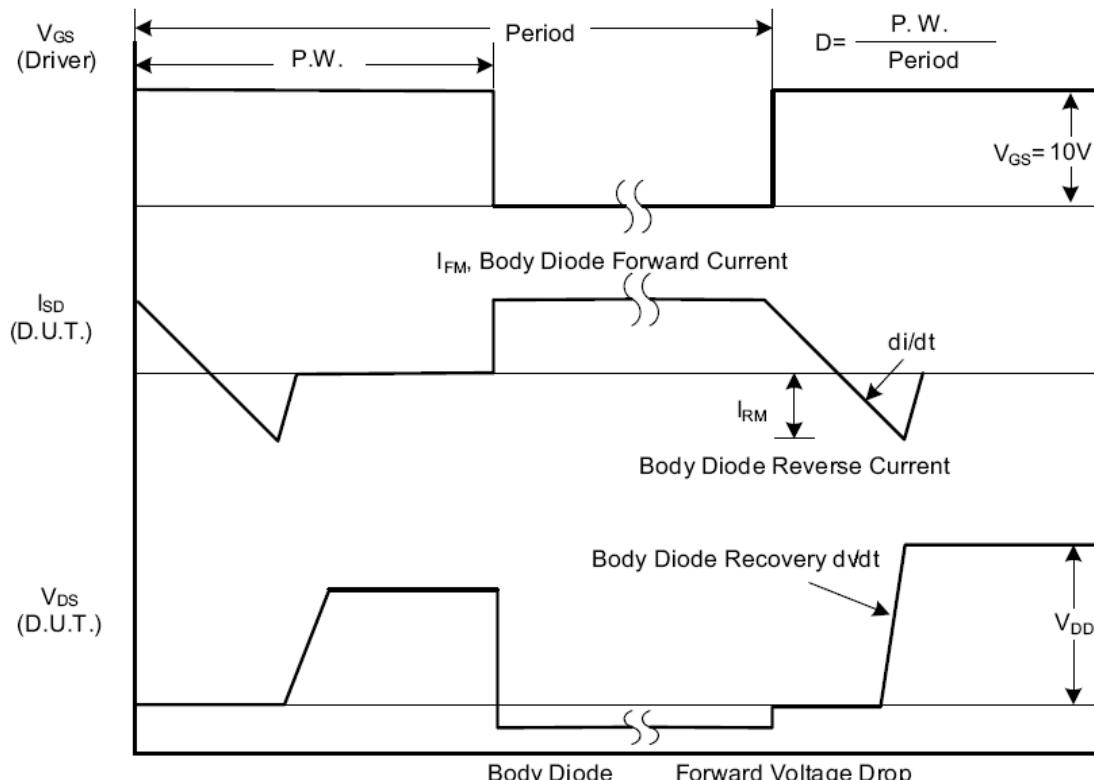


Fig. 1.2 Peak Diode Recovery  $dv/dt$  Waveforms

## Test Circuits and Waveforms (Cont.)

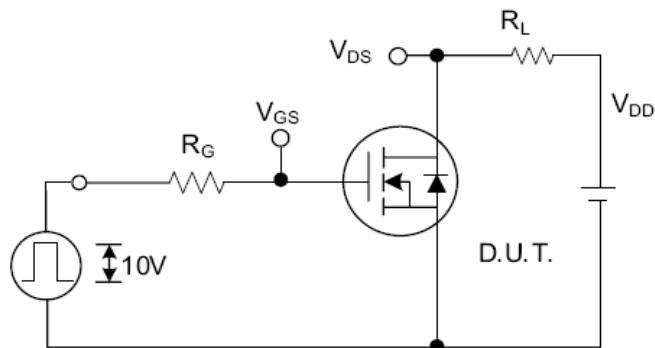


Fig. 2.1 Switching Test Circuit

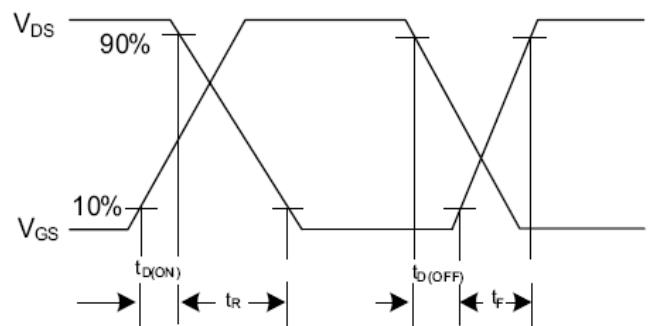


Fig. 2.2 Switching Waveforms

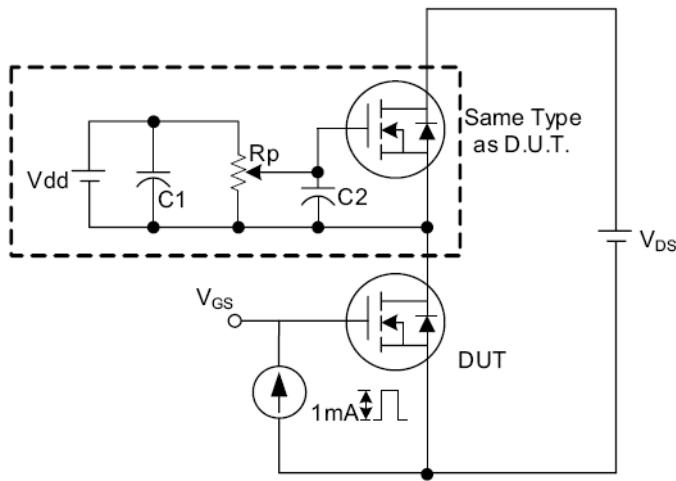


Fig. 3 . 1 Gate Charge Test Circuit

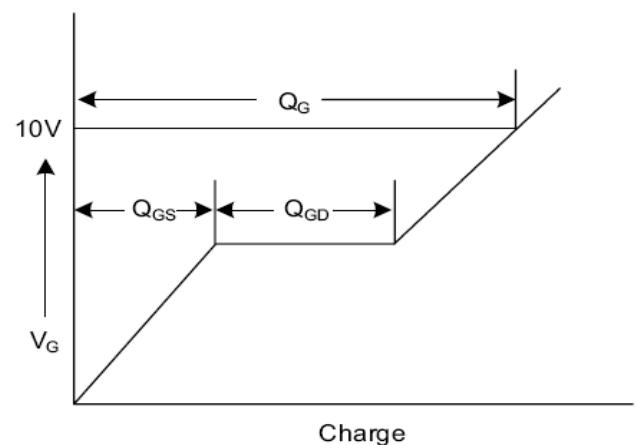


Fig. 3 . 2 Gate Charge Waveform

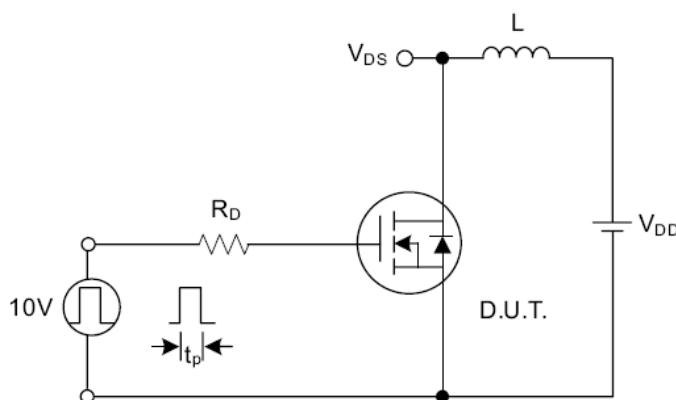


Fig. 4.1 Unclamped Inductive Switching Test Circuit

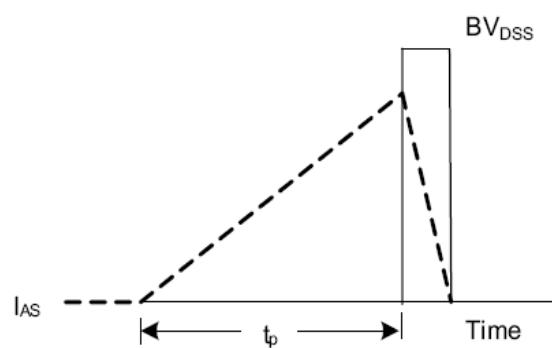


Fig. 4.2 Unclamped Inductive Switching Waveforms

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